Filename: PMP10098RevC - BoM.xls

Variant: None

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## PMP10098 REV C Bill of Materials

Item #	Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
1	C1, C3	2	1000pF	C907U102MYVDBA7317	Kemet	CAP, CERM, 1000pF, 300V, +/-20%, Y5V, Radial Disc 7mm, Is=7.5	Radial Disc 7.5mm, Is=7.5
2	C1, C3	1	0.1uF		EPCOS Inc	CAP, Film, 0.1uF, 630V, +/-20%, TH	B32922 10.5mm
	C2 C4			B32922C3104M			
3		1	2200pF	C907U222MZVDBA7317	Kemet	CAP, CERM, 2200 pF, 300 V, +/- 20%, Y5V	Radial Disc 7.5mm, Is=7.5
4	C5, C6, C7,	5	1uF	GRM188R71E105KA12D	MuRata	CAP, CERM, 1 μF, 25 V, +/- 10%, X7R, 0603	0603
	C13, C21						
5	C8	1	2200pF	GRM21AR72E222KW01D	MuRata	CAP, CERM, 2200 pF, 250 V, +/- 10%, X7R, 0805	0805
6	C9, C10	2	6.8uF	EKXG401ELL6R8MJ16S	United Chemi-Con	CAP, AL, 6.8uF, 400V, 20%, 100mA	10x16
7	C11, C12	2	470uF	EEE-FK1C471P	Panasonic	CAP, AL, 470 μF, 16 V, +/- 20%, 0.16 ohm, SMD	SMT Radial F
8	C14, C15,	4	0.1uF	GCM188R71H104KA57D	MuRata	CAP, CERM, 0.1 µF, 50 V, +/- 10%, X7R, 0603	0603
	C17, C20						
9	C16	1	47uF	EEE-FK1E470P	Panasonic	CAP, AL, 47 µF, 25 V, +/- 20%, 0.36 ohm, SMD	SMT Radial D
10	C18	1	0.01uF	GRM188R71H103KA01D	MuRata	CAP, CERM, 0.01 µF, 50 V, +/- 10%, X7R, 0603	0603
11	C19	1	1000pF	GRM188R71H102KA01D	MuRata	CAP, CERM, 1000 pF, 50 V, +/- 10%, X7R, 0603	0603
12	C22	1	100pF	GRM1885C1H101JA01D	MuRata	CAP, CERM, 100 pF, 50 V, +/- 5%, C0G/NP0, 0603	0603
13	C23	1	470pF	GRM188R71H471KA01D	MuRata	CAP, CERM, 470 pF, 50 V, +/- 10%, X7R, 0603	0603
14	D1	1	1.15V	RH06-T	Diodes Inc.		MiniDIP
						Diode, Switching-Bridge, 600V, 0.5A, MiniDIP	
15	D2	11	MURA160	MURA160T3G	ON Semiconductor	Diode, Ultrafast, 600V, 1A, SMA	SMA
16	D3	1	6.8V	MMSZ5235B-7-F	Diodes Inc.	Diode, Zener, 6.8 V, 500 mW, SOD-123	SOD-123
17	D4	1	200V	RF071M2S	Rohm	Diode, Ultrafast, 200 V, 1 A, SOD-123	SOD-123
18	D6, D7, D8	3	200V	BAS21-7-F	Diodes Inc.	Diode, Switching, 200 V, 0.2 A, SOT-23	SOT-23
19	FID1, FID2,	4		N/A	N/A	Fiducial mark. There is nothing to buy or mount.	N/A
	FID3, FID4						
20	J1	1		OSTTA034163	On-Shore Technology	Terminal Block, 3x1, 5.08 mm, TH	3x1 Terminal Block
21	J2, J3	2		ED555/2DS	On-Shore Technology	Terminal Block, 6A, 3.5mm Pitch, 2-Pos, TH	7.0x8.2x6.5mm
22	L1	1	20mH	744821120	Wurth Elektronik eiSos	Coupled inductor, 20 mH, 0.5 A, 1.0 ohm, +/- 30%, TH	15 x 18 x 7.5mm
23	L2	1	1mH	744772102	Wurth Elektronik eiSos	Inductor, Shielded Drum Core, Metal Composite, 1 mH, 0.3 A, 1.7 ohm	Dia 8x10mm
24	Q1	1	SI2309DS	SI2309DS	Vishay-Siliconix	MOSFET, P-CH, -60V, -1.0A, SOT-23	SOT-23
25	Q2	1	FMMT560	FMMT560	Diodes Inc.	Transistor, PNP, -500V, -500mA, SOT-23	SOT-23
26	Q3	1	0.2V	MMBT3904	Diodes Inc.	Transistor, NPN, 40V, 0.2A, SOT-23	SOT-23
27	Q4	1	650V	SPD03N60C3	Infineon Technologies	MOSFET, N-CH, 650 V, 3.2 A, DPAK	DPAK
28	R1	1	47k	CRCW120647K0JNEA	Vishay-Dale	RES, 47 k, 5%, 0.25 W, 1206	1206
29	R2	1	40.2k	CRCW060340K2FKEA	Vishay-Dale	RES, 40.2 k, 1%, 0.1 W, 0603	0603
30	R3	1	6.8k	CRCW12066K80JNEA	Vishay-Dale	RES, 6.8 k, 5%, 0.25 W, 1206	1206
31	R4	11	100	CRCW0603100RFKEA	Vishay-Dale	RES, 100, 1%, 0.1 W, 0603	0603
32	R5, R6, R7	3	1.00Meg	CRCW06031M00FKEA	Vishay-Dale	RES, 1.00 M, 1%, 0.1 W, 0603	0603
33	R8, R12,	3	1.00Meg	CRCW08051M00FKEA	Vishay-Dale	RES, 1.00 M, 1%, 0.125 W, 0805	0805
	R15		_				
34	R9. R21	2	10.0	CRCW060310R0FKEA	Vishay-Dale	RES, 10.0, 1%, 0.1 W, 0603, RES, 10.0 ohm, 1%, 0.1W, 0603	0603
35	R10	1	49.9	CRCW060349R9FKEA	Vishay-Dale	RES, 49.9, 1%, 0.1 W, 0603	0603
36	R11, R14,	5	100k	CRCW0603100KFKEA	Vishay-Dale	RES, 100 k, 1%, 0.1 W, 0603	0603
	R19, R20,	_			1.5		
	R28						
37	R13	1	37.4k	CRCW060337K4FKEA	Vishay-Dale	RES, 37.4 k, 1%, 0.1 W, 0603	0603
38	R13	1	37.4K 470k	CRCW060337K4FKEA			0603
					Vishay-Dale	RES, 470k ohm, 5%, 0.1W, 0603	
39	R17, R101	2	0	CRCW06030000Z0EA	Vishay-Dale	RES, 0, 5%, 0.1 W, 0603	0603
40	R18	1	4.75k	CRCW06034K75FKEA	Vishay-Dale	RES, 4.75 k, 1%, 0.1 W, 0603	0603
41	R22, R23	2	2.21k	CRCW06032K21FKEA	Vishay-Dale	RES, 2.21k ohm, 1%, 0.1W, 0603, RES, 2.21 k, 1%, 0.1 W, 0603	0603
42	R24	1	0.47	ERJ-6RQFR47V	Panasonic	RES, 0.47, 1%, 0.125 W, 0805	0805
43	R25	1	35.7k	CRCW060335K7FKEA	Vishay-Dale	RES, 35.7 k, 1%, 0.1 W, 0603	0603
44	R26	1	165k	CRCW0603165KFKEA	Vishay-Dale	RES, 165 k, 1%, 0.1 W, 0603	0603
45	R27	1	11.5k	CRCW060311K5FKEA	Vishay-Dale	RES, 11.5 k, 1%, 0.1 W, 0603	0603
46	RV1	1	275V	S10K275E2	EPCOS Inc	Varistor 275V RMS 10MM Radial, TH	10mm Radial
47	T1	1	4 mH	750370271	Wurth Elektronik eiSos	Transformer, 4 mH, SMT	SMT, 9-Leads, Body 22.74x13.1mm
48	TP1, TP3	2	White	5002	Keystone	Test Point, Miniature, White, TH	White Miniature Testpoint
49	TP2. TP5	2	Red	5000	Keystone	Test Point, Miniature, Red, TH	Red Miniature Testpoint
50	TP4, TP6	2	Black	5001	Keystone	Test Point, Miniature, Red, 111	Black Miniature Testpoint
51	U1	1	Diack	LP2980AIM5-5.0	Texas Instruments	Micropower 50 mA Ultra Low-Dropout Regulator, 5-pin SOT-23	MF05A
52		-	1				
	U2	1		LM3481MM	Texas Instruments	High Efficiency Low-Side N-Channel Controller for Switching Regulators	MUB10A
53	U3	11	1	LMV431AIMF/NOPB	Texas Instruments	Low-Voltage (1.24V) Adjustable Precision Shunt Regulators	MF03A
54	U4	1		TCMT1107	Vishay-Semiconductor	Optocoupler, 3.75kV RMS, SMT	SOP-4

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